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April 2015

FDB110N15A — N-Channel PowerTrench[®] MOSFET

FDB110N15A N-Channel PowerTrench[®] MOSFET 150 V, 92 A, 11 m Ω

Features

- $R_{DS(on)}$ = 9.25 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 92 A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

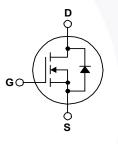
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

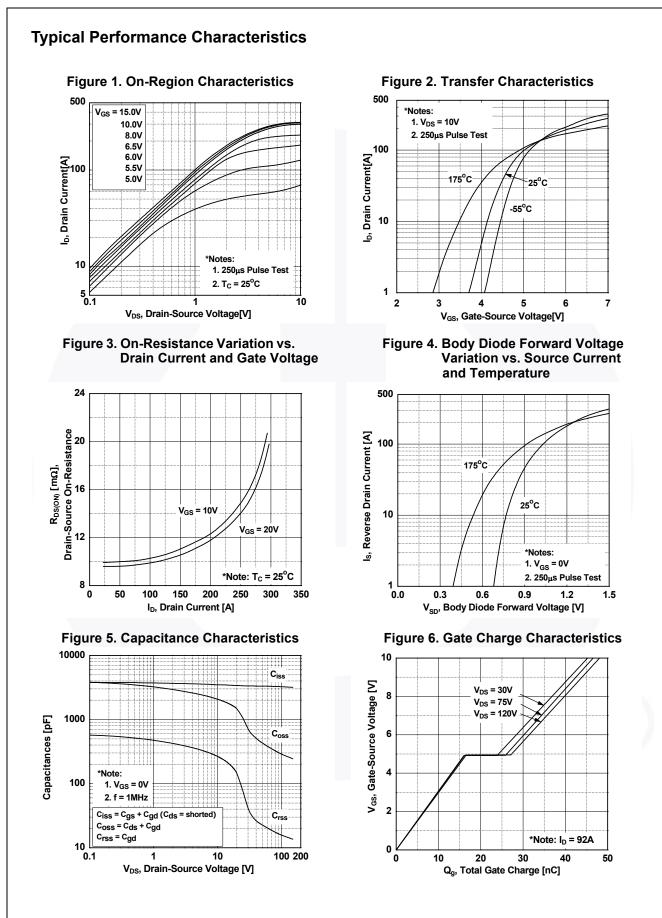
Symbol		Parameter	FDB110N15A	Unit		
V _{DSS}	Drain to Source Voltage	to Source Voltage			V	
V _{GSS}	Cata ta Sauraa Valtaga	- DC		±20	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		92	A	
	Drain Current	- Continuous (T _C = 100 ^o C)		65		
I _{DM}	Drain Current	- Pulsed	(Note 1)	369	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		365	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6	V/ns		
P _D	Dower Discinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		234	W	
	Power Dissipation	- Derate Above 25°C		1.56	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

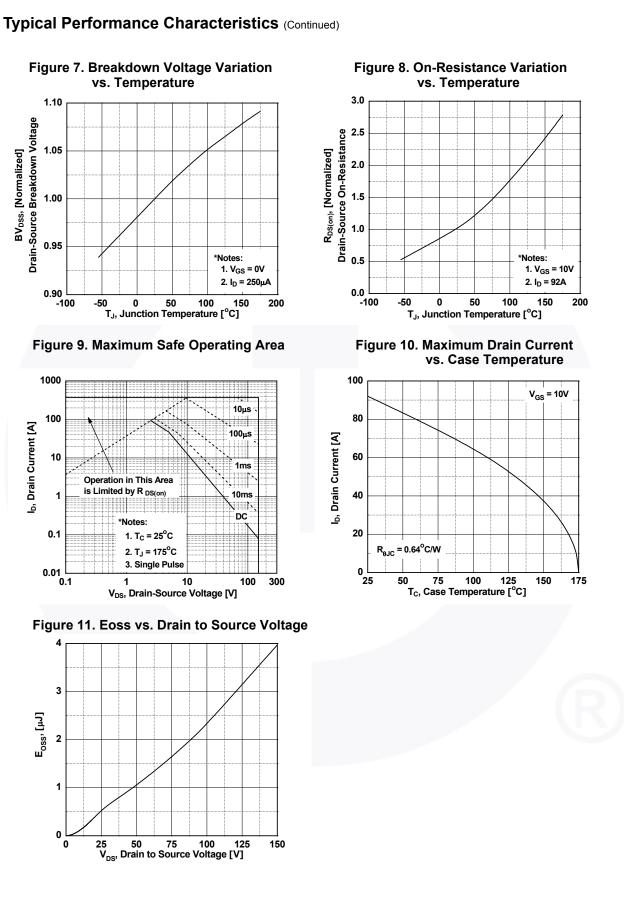
Thermal Characteristics

Symbol	Parameter	FDB110N15A	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.64	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	C/W	

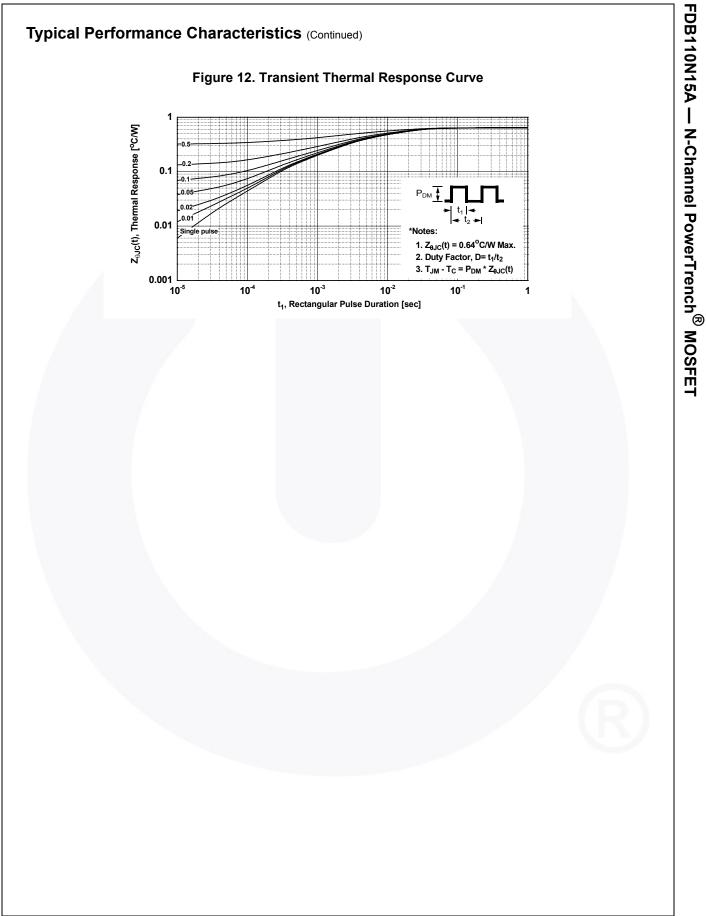
Fait Null	nber	Top Mark	Package	age Packing Method Reel Size		Тар	e Width	Qua	ntity
FDB110N	15A	FDB110N15A	D ² -PAK	Tape and Reel	330 mm	2	4 mm	800	units
Electrica	l Chara	acteristics T _C = 25°	^o C unless ot	herwise noted.					
Symbol		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics	3							
BV _{DSS}	Drain to	Source Breakdown Voltag	ae I	_D = 250 μA, V _{GS} = 0 V		150	-	-	V
ΔBV _{DSS}		Breakdown Voltage Temperature					0.00		V/°C
$/\Delta T_J$	Coefficient			$I_D = 250 \ \mu$ A, Referenced to 25° C		-	0.09	-	V/°C
I _{DSS}	Zero Ga	te Voltage Drain Current		V _{DS} = 120 V, V _{GS} = 0 V		-	-	1	μA
USS	Zero Gate Voltage Drain Current			V_{DS} = 120 V, T_{C} = 150°C		-	-	500	μΑ
GSS	Gate to Body Leakage Current		1	V_{GS} = ±20 V, V_{DS} = 0 V		-	-	±100	nA
On Charac	teristics	3							
V _{GS(th)}	-	reshold Voltage	,	V _{GS} = V _{DS} , I _D = 250 μA		2.0	_	4.0	V
R _{DS(on)}		rain to Source On Resista		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 200 \mu$		-	9.25	11.0	mΩ
9FS		I Transconductance		$V_{\rm DS} = 10$ V, $I_{\rm D} = 92$ A		-	118	-	S
	_								-
Dynamic C	haracte	ristics							
C _{iss}	Input Ca	apacitance				-	3390	4510	pF
C _{oss}	Output C	Capacitance		V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-	334	445	pF
C _{rss}	Reverse	Transfer Capacitance				-	14	-	pF
C _{oss} (er)	Engry R	eleted Output Capacitance	e '	V _{DS} = 75 V, I _D = 92 A		-	583	-	pF
Q _{g(tot)}	Total Ga	te Charge at 10V				-	47	61	nC
Q _{gs}	Gate to	Source Gate Charge		$V_{\rm GS} = 10 \text{ V}, \text{ V}_{\rm DS} = 75 \text{ V},$	-	16	-	nC	
Q _{gs2}	Gate Ch	arge Threshold to Plateau	u	I _D = 92 A		-	7.9	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge			(Note 4)	-	9.7	-	nC
Switching	Charact	eristics							
		Delay Time				-	25	60	ns
t _{d(on)} t		Rise Time		V_{DD} = 75 V, I _D = 92 A, V _{GS} = 10 V, R _G = 4.7 Ω		-	26	62	ns
t _{d(off)}		Delay Time				-	46	102	ns
te		Fall Time			(Note 4)		14	38	ns
ESR		ent Series Resistance (G-S	S) 1	(NOLE 4)		7.	2.5	-	Ω
			,						
Jrain-Sour	1	le Characteristics							
I _S		Maximum Continuous Drain to Source Diode Forward Current				-	-	92	A
I _{SM}		Naximum Pulsed Drain to Source Diode Forward Current				-	-	369	Α
V _{SD}		Source Diode Forward Vo		V _{GS} = 0 V, I _{SD} = 92 A		-	-	1.25	V
t _{rr}		Recovery Time		$V_{GS} = 0 \text{ V}, \text{ I}_{SD} = 92 \text{ A}, \text{ V}_{DD} = 75 \text{ V}, \\ \text{dI}_{\text{F}}/\text{dt} = 100 \text{ A}/\mu\text{s}$		-	89	-	ns
Q _{rr}	Reverse	Recovery Charge	(-	255	-	nC

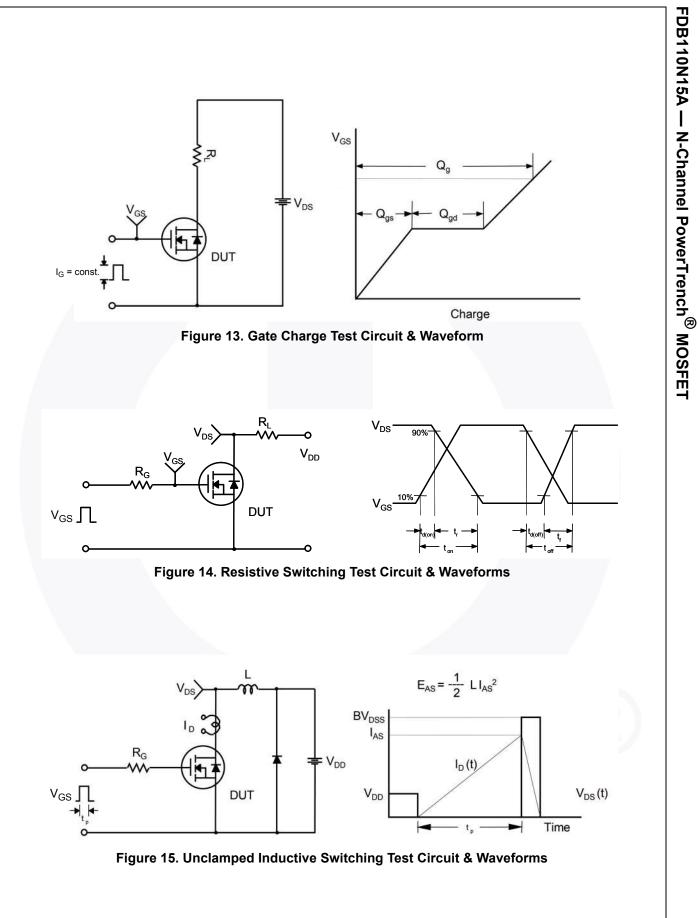






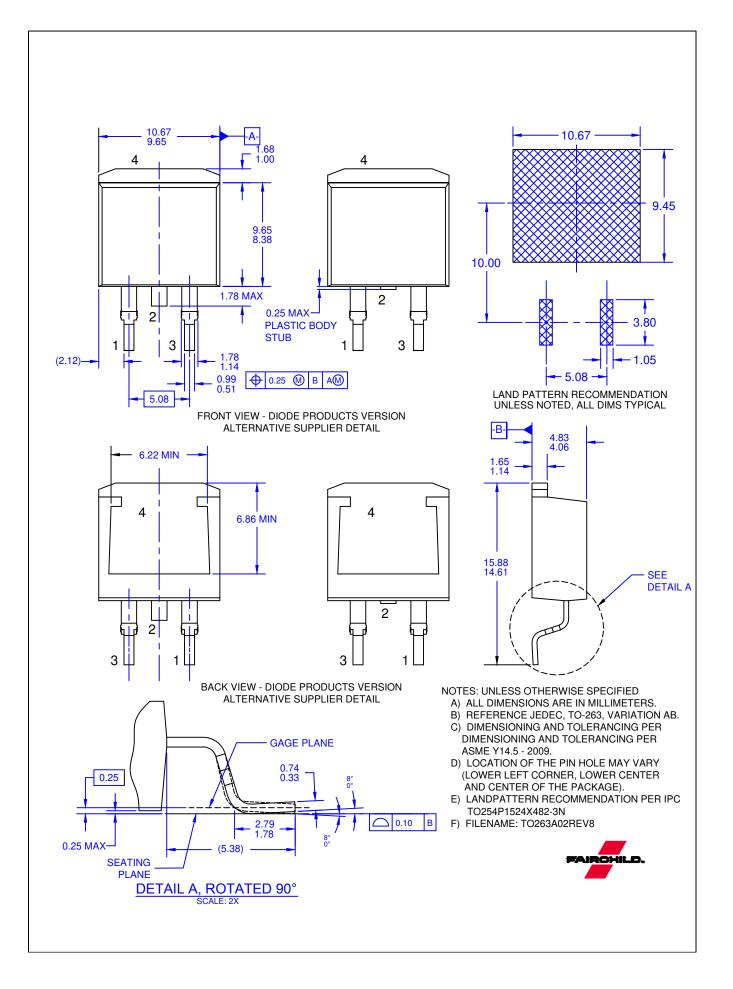
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DUT + v_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F V_{DD} $\prod V_{GS}$ • dv/dt controlled by R_G • I_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{DD} Body Diode Forward Voltage Drop Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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